

Content of Press Kit



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Images

REN2508

Renesas Extends Mid-Class AI Processor Line-Up with RZ/V2N Integrating DRP-AI Accelerator for Smart Factories and Intelligent Cities of Tomorrow



REN2507

Renesas Releases Certified PROFINET-IRT and PROFIdrive Software Stacks for RZ/T and RZ/N Series Microprocessors



REN2506

Renesas and Altium Announce Introduction of Renesas 365, Powered by Altium: Groundbreaking Industry Solution for Software-Defined Products

[Visit Hall 5, Renesas Digital Booth 5-371 for demos](#)



REN2505

Renesas Teams Up with Applus+ Laboratories to Achieve PSA Certified Level 1 with CRA Extension for Three New MCU Groups



REN2503

Renesas Debuts Ultra-Low-Power RA4L1 MCUs with Capacitive Touch, Segment LCD and Robust Security

MCUs with Segment LCD and Advanced Security for Battery-Powered Applications



REN2502

Renesas Introduces New MOSFETs with Exceptional Performance

High Efficiency 100V Power MOSFETs with Split Gate Technology



REN2501

Honda and Renesas Sign Agreement to Develop High-Performance SoC for Software-Defined Vehicles



REN2440

Renesas Introduces USB PD EPR Solution Featuring Type-C Port Controller and Buck-Boost Battery Charger

Industry Leading 48V USB-PD EPR Solution



REN2439

Renesas Extends Line-up For Industrial Ethernet and Multi-Axis Motor Control Solutions with High Performance Quad-Core Application Processor

RZ/T2H MPU Provides Powerful Application Processing and Fast Real-Time Control



REN2437

Renesas Introduces Industry's First Complete Memory Interface Chipset Solutions for Second-Generation DDR5 Server MRDIMMs

Industry's First Complete Memory Interface Chipset Solutions for Next Generation DDR5 Server MRDIMMs

